	nd specifications are		REVISIONS		
and may not be re	ensitron Corporation produced, copied or	REV	DESCRIPTION	DATE	APPROVED
used without w	ritten permission	A	E0158		
 2. All dimensificatures. 3. All dimensificatures. 3. All dimensificatures. 4. Precaution guidelinesificature. Handli T Power Iconstruction P U M T T D Iconstruction Iconstruction Iconstruction Iconstruction P U M F Vertician 	sions are in millime ns:These precautions is may void the warr ling precautions: his device is suscept r supply precautions: dentify and, at all time ariance between mod revent the application lise a clean power so haximum ratings of th he +5V power of the data bus to be driv DO NOT install a capa evel. The capacitor co own, possibly damag ating precautions: DO NOT plug or unplu linimize the cable len or models with EL ba oltage extremes whice	tions apply to ters. Ins apply equants anty and can be to Electron as, observe at lels. In of reverse p urce free from e module. module shoule en when the locitor betweer ombines with ing the module gth emodule gth between icklights, do n h may arc with	 b standard modules. This information may variable standard modules. This information may variable standard modules from all makers, not just Densible cause problems ranging from erratic operation. c-Static Discharge (ESD) damage. Observe Anti-Sipolation of the standard transfers for both logic and LC drive olarity to VDD and Vss, however briefly. c transients. Power up conditions are occasionally d also supply the power to all devices which may alogic supply to the module is turned off. c the Vo (contrast) pin and ground. VDD must, at a the contrast potentiometer to form an R-C network 	itron. Violation of t n to catastrophic c tatic precautions. vers. Note that there "jolting" and may ex access the display. all times, exceed the k which "holds-up" V ength 30 cm).	these display e is some xceed the Don't allow Vo voltage /o, at power-
 Ir W S P A P h D If o 	nder the elastomeric older. fount the module so t surface of LCD panel olarizer. Avoid conta enzene. LWAYS employ anti- revent moisture build umidity. OO NOT store in direct leakage of the liquid r clothing becomes co ess otherwise spe	he major cau connection at hat it is free f should not be ct and clean of static procedu -up upon the t sunlight. crystal mater ontaminated f ecified)	: se of module difficulty. Use of flux cleaner is not read cause display failure. Densitron recommends t rom torque and mechanical stress. touched or scratched. The display front surface i only when necessary with soft, absorbent cotton d ure while handling the module. module and observe the environmental constraint ial should occur, avoid contact with this material, p by the liquid crystal material, wash thoroughly with	he use of Kester "24 s an easily scratche ampened with petro s for storage tempe particularly ingestion	45" no-clean ed, plastic pleum rature and
Unless otherwise specified:	APPROVALS DRAWN	DATE	DENSITRON COR	PORATIO)N
Dimensions are mm			TORRANCE,	CA	

Tolerances are: $X = \pm 3$ $X = \pm 0.5$	CHECKED	TITLE	2 LINE X 16 CHARACTERS LCD N	IODULE
	ISSUED	DWG. NO.	LM2000	SHEET 1 OF 8

1.0 **DESCRIPTION**

Dot matrix display module consisting of a Liquid Crystal Display, CMOS driver and controller LSI, printed circuit board and metal support frame.

Available LC fluids types are: TN (twisted nematic), TN-H (extended temperature range TN), NTN (supertwisted nematic), NTN-H (extended temperature range NTN).

Options include electroluminescent (EL) backlighting.

2.0 MECHANICAL CHARACTERISTICS

Item	Specifications	Unit
Package Dimensions	80.0 (W) x 36.0 (H) x 10.6 max. (D)	mm
Display format	2 line x 16 characters	-
Character font format	5 (W) x 7 (H) with attached cursor	dots
Driving method	1/16	duty
Dot size	0.55 (W) x 0.5 (H)	mm
Dot pitch	0.60 (W) x 0.55 (H)	mm
Character Size	2.95 (W) x 4.35 (H)	mm
Active display area	57.7 (W) x 9.4 (H)	mm
Viewing area	64.5 (W) x 13.8 (H)	mm
Weight		g

Notes:W-Width;H-Height;D-Depth.

3.0 ABSOLUTE MAXIMUM RATINGS

Vss=0V;Ta=25°C

Item	Symbol	TN, NTN		TN-H,	NTN-H	Unit
		Min.	Max.	Min.	Max.	
Logic supply voltage	VDD-VSS	0	7	0	7	V
LC driver supply voltage	Vdd-Vo	0	6	0	13	V
Operating temperature	Тор	0	+50	-20	+70 (Note 3)	°C
Storage temperature (Note 1)	TST	-20	+70	-30	+80	
Humidity: Operating (@40°C)	-	-	85%	-	85%	RH (Note 2)
Non-operating (@40°C)	-	-	95%	-	95%	RH (Note 2)

Notes: 1: Tested to 100 hrs.

2: Refers to non-condensing conditions.

3. It is not recommended to operate EL lamp above 50°C.

4.0 ELECTRICAL CHARACTERISTICS

VDD=5±0.25V;1								
Item	Symbol	Test Condition	Min.	Тур.	Max.	Unit		
Input "High" voltage	Vih	-	2.2	-	Vdd	V		
Input "Low" voltage	VIL	-	-	-	0.6	V		
Output "High" voltage	Vон	Іон=0.205mA	2.4	-	-	V		
Output "Low" voltage	Vol	IoL=1.2mA	-	-	0.4	V		
Power supply current	ldd	Vdd=5.0V	-	1	-	mA		

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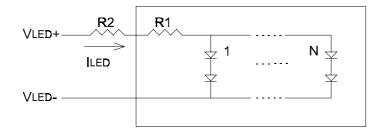
5.0 **RECOMMENDED LC DRIVE VOLTAGE (VDD-VO)**

		•	,	VDD=5.0±0.25V
Temperature	TN	TN-H	NTN	NTN-H
Ta= -20°C	-	9.7	-	9.5
Ta= 0°C	5.0	9.2	4.5	8.9
Ta= 25°C	4.7	8.7	4.3	8.4
Ta= 50°C	4.3	8.3	4.0	8.2
Ta=70°C	-	8.0	-	7.9

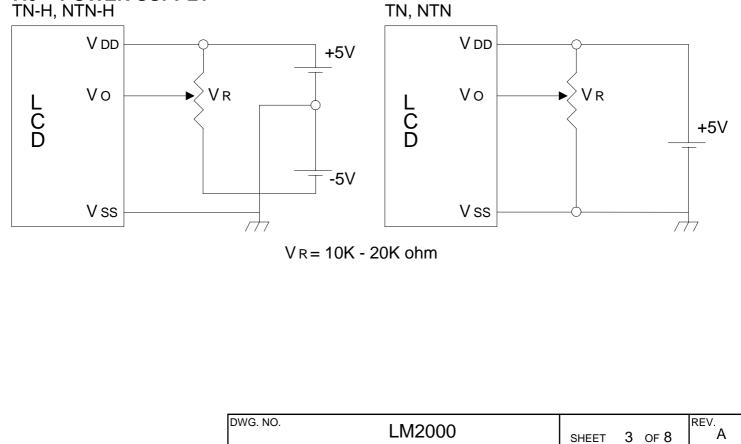
6.0 **BACKLIGHT SPECIFICATIONS:**

Ta=20°C,60%RH,Darkroom.

Item	Symbol	Тур.	Max.	Unit
EL lamp input voltage	VEL	100	150	Vrms
EL lamp input current	IEL	1.5	3.0	mA
EL lamp input frequency	Fel	400	800	Hz
Life to half initial brightness	-	2500	3000	Hours
Recommended backlight inverter	-	DAS5V4	-	-

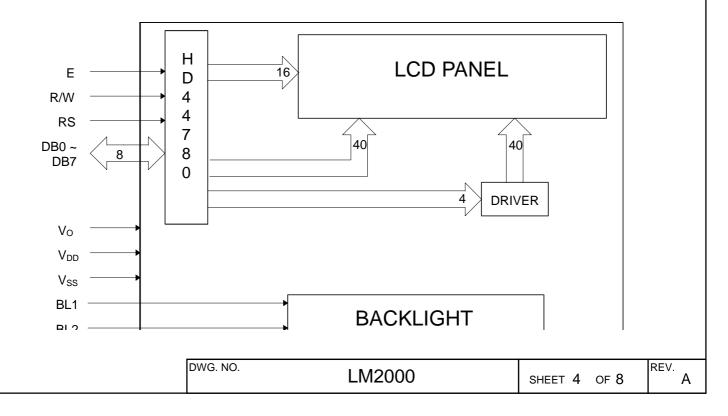


POWER SUPPLY 7.0 TN-H, NTN-H



8.0 INTERFACE DESCRIPTION

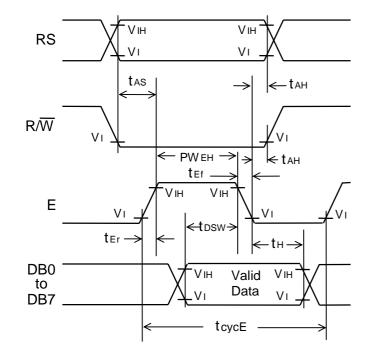
Pin No.	Symbol	I/O	Function
1	Vss	-	Ground (0V)
2	Vdd	-	Logic Supply Voltage (+5V)
3	Vo	-	LC Drive voltage for contrast adjustment
4	RS		Register Select 0: Instruction Register
			1: Data Register
5	R/W	Ι	Read / Write 0: Data Write (Module ← MPU)
			1: Data Read (Module→MPU)
6	E		Enable Signal Active High (H→L)
7	DB0	I/O	Bi-directional data bus line 0
8	DB1	I/O	Bi-directional data bus line 1
9	DB2	I/O	Bi-directional data bus line 2
10	DB3	I/O	Bi-directional data bus line 3
11	DB4	I/O	Bi-directional data bus line 4
12	DB5	I/O	Bi-directional data bus line 5
13	DB6	I/O	Bi-directional data bus line 6
14	DB7	I/O	Bi-directional data bus line 7
BL1	Vel	-	EL backlight input voltage (from output of DC-AC inverter)
BL2	Vel	-	EL backlight input voltage (from output of DC-AC inverter)



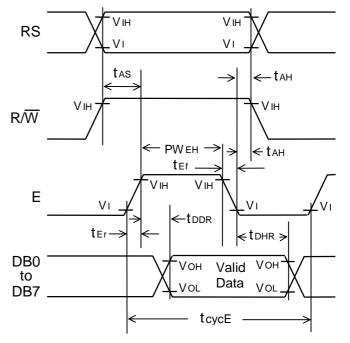
10.0 TIMING CHARACTERISTICS

Item	Symbol	Min.	Тур.	Max.	Unit
Enable cycle time	TcycE	500	-	-	nS
Enable pulse width	РWeh	230	-	-	nS
Enable rise / fall time	tEr/tEf	-	-	20	nS
Address set-up time	tas	40	-	-	nS
Address hold time	tан	10	-	-	nS
Data delay time	tddr	-	-	160	nS
Data hold time (Write)	t DHW	10	-	-	nS
Data hold time (Read)	t DHR	5	-	-	nS
Data set-up time	tDSW	80	-	-	nS

WRITE OPERATION



READ OPERATION



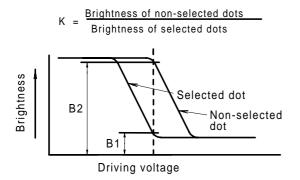
11.0 DD RAM ADDRESS vs. DISPLAY POSITION

Character	1	2	3	4	5	6	7	8	9	10	11	 14	15	16
Line 1	00	01	02	03	04	05	06	07	08	09	0A	 0D	0E	0F
Line 2	40	41	42	43	44	45	46	47	48	49	4A	 4D	4E	4F
				DWG.	NO.				4200					REV

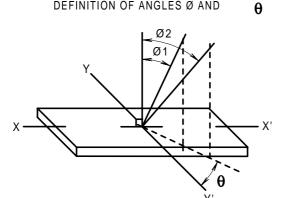
12.0 OPTICAL CHARACTERISTICS

lte	em	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Contrast ratio T	N, TN-H	K	Ø=20° θ=0°	3	-	-	-
Contrast ratio N	TN	K	Ø=20° θ=0°	4	-	-	-
Contrast ratio N	TN-H	K	Ø=20° θ=0°	5	-	-	-
Viewing angle	TN, TN-H	Ø2-Ø1	θ=0° K <u>></u> 1.4	20	-	-	Deg.
		θ	Ø=20° K=1.4	±30	-	-	Deg.
Viewing angle	NTN	Ø2-Ø1	θ=0° K <u>></u> 1.4	40	-	-	Deg.
		θ	Ø=20° K=1.4	±30	-	-	Deg.
Viewing angle	NTN-H	Ø2-Ø1	θ=0° K <u>></u> 1.4	40	-	-	Deg.
		θ	Ø=20° K=1.4	±40	-	-	Deg.
Response time	Rise	tr	Ø=20° θ=0°	-	150	250	mS
	Fall	tr	Ø=20° θ=0°	-	150	250	mS

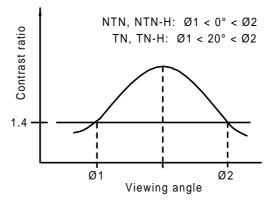




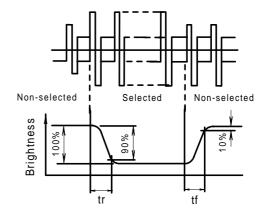
DEFINITION OF ANGLES Ø AND

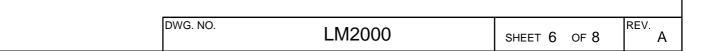


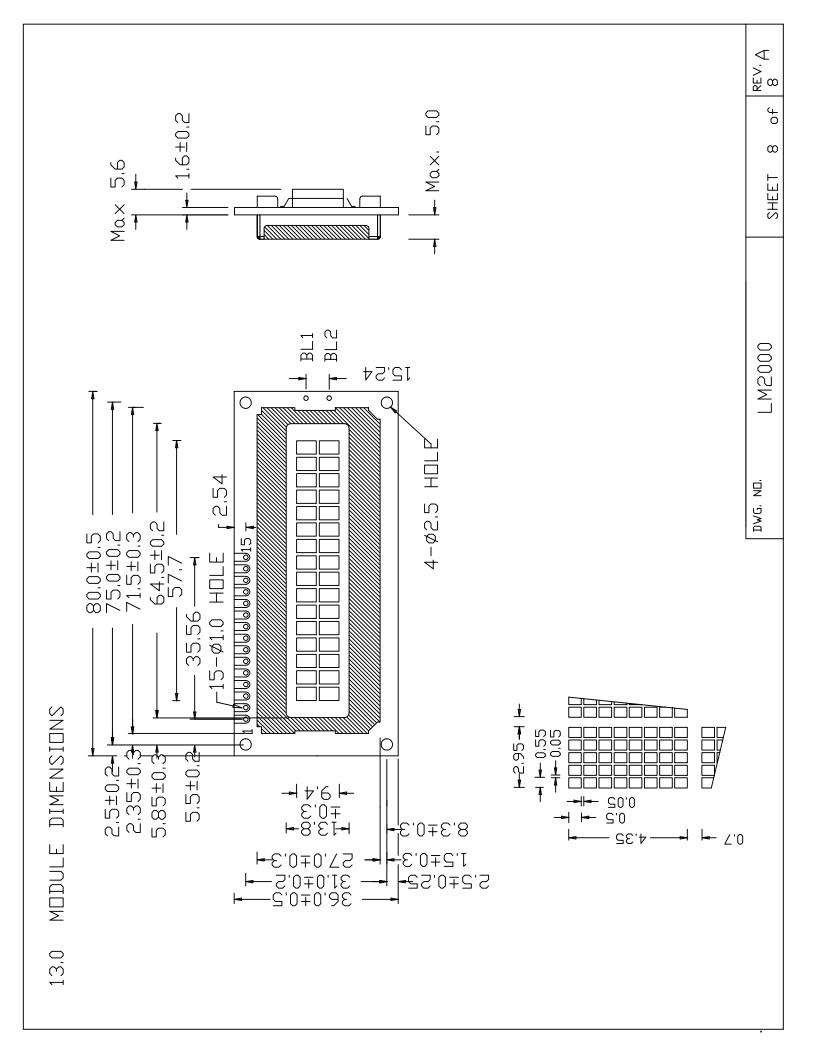
CONTRAST VERSUS VIEWING ANGLE

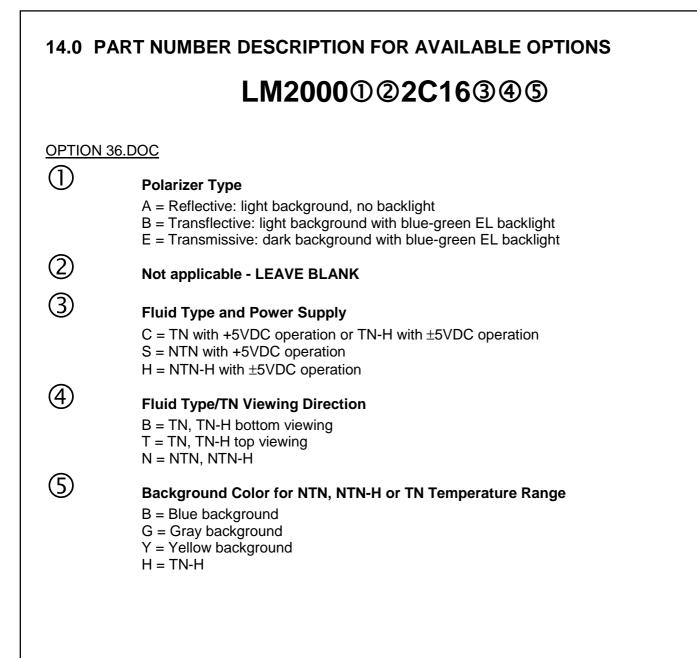


DEFINITION OF OPTICAL RESPONSE









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